



钲地半导体
Tudi Semiconductor

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Product Specification

TUDI-MAX232E

MAX232E Dual RS-232 Driver/Receiver with IEC61000-4-2 Protection

网址 www.sztdbdt.com Q

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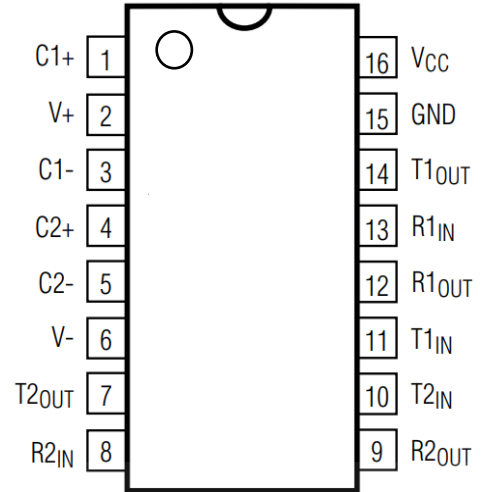
semiconductor device
manufacturer

- Design
- research and development
- production
- and sales



Features

- Meets or exceeds requirements of TIA/RS-232-F and ITU Recommendation V.28
- Provides E protection for RS-232 bus pins
 - $\pm 15\text{kV}$ Human Body Model (HBM)
 - $\pm 8\text{kV}$ IEC610004-2, Contact Discharge
 - $\pm 15\text{kV}$ IEC61000-4-2, Air Gap Discharge
- Powered from a single V supply with $1\mu\text{F}$ charge pump capacitor
- Data rates up to 250kbit/s
- Two drivers and two receivers
- Low power current



Description

The MAX232E is a dual driver and receiver that contains a charge-pump voltage generator for providing the proper RS-232- voltage levels from a single 5V supply. Each receiver converts an RS-232 input to 5V TTL/CMOS levels. The receiver has a typical of 1.3V, a typical hysteresis of 0.5V, and can accept $\pm 30\text{V}$ input. Each driver converts TTL/CMOS levels to TIA/EIA-232-F levels.

Applications

- TIA/EIA-232-F
- Battery-powered system
- Terminal
- Modem
- Computer



Pin description

Pin No	Symbol	Pin name
01	C1+	Output of external capacitance of positive voltage multiplier unit
02	V+	Output of positive voltage of multiplier unit
03	C1-	Output of external capacitance of positive voltage multiplier unit
04	C2+	Output of external capacitance of negative voltage multiplier unit
05	C2-	Output of external capacitance of negative voltage multiplier unit
06	V-	Output of negative voltage of multiplier unit
07	T2oUT	Output of transmitter data(levels RS-232)
08	R2IN	Input of receiver data(levels RS-232)
09	R2oUT	Output of receiver data(levels TTL/KMOS)
10	T2IN	Input of transmitter data(levels TTL/KMOS)
11	T1n	Input of transmitter data(levels TTL/KMOS)
12	R1oUT	Output of receiver data(levels TTL/KMOS)
13	R1n	Input of receiver data(levels RS-232)
14	T1oUT	Output of transmitter data(levels RS-232)
15	GND	Common output
16	Vcc	Supply output of voltage source



Recommended Operating Conditions				
Symbol	Parameter	Rate		Unit
		min	max	
Vcc	Supply voltage	4.5	5.5	V
V+	Transmitter output high voltage	5.0	-	
V-	Transmitter output low voltage	-5.0	-	
VTIN	Transmitter input voltage	0	Vcc	
VRIN	Receiver input voltage	-30	30	
Isc	Transmitter short circuit output current	-	±60	
Ta	Ambient temperature	-40	85	C
Maximum conditions				
Symbol	Parameter	Rate		Unit
		min	max	
Vcc	Supply voltage	-0.3	6.0	V
V+	Transmitter high output voltage	Vcc-0.3	14	
V-	Transmitter low output voltage	-0.3	-14	
VTIN	Transmitter input voltage	-0.3	V+ +0.3	
VRIN	Receiver input voltage	-30	30	
Pp	Dissipated powerDIP-package	-		
Isc	Output current of transmitter short circuit	-	Continuously	mA
Ta	Ambient temperature	-60	150	C



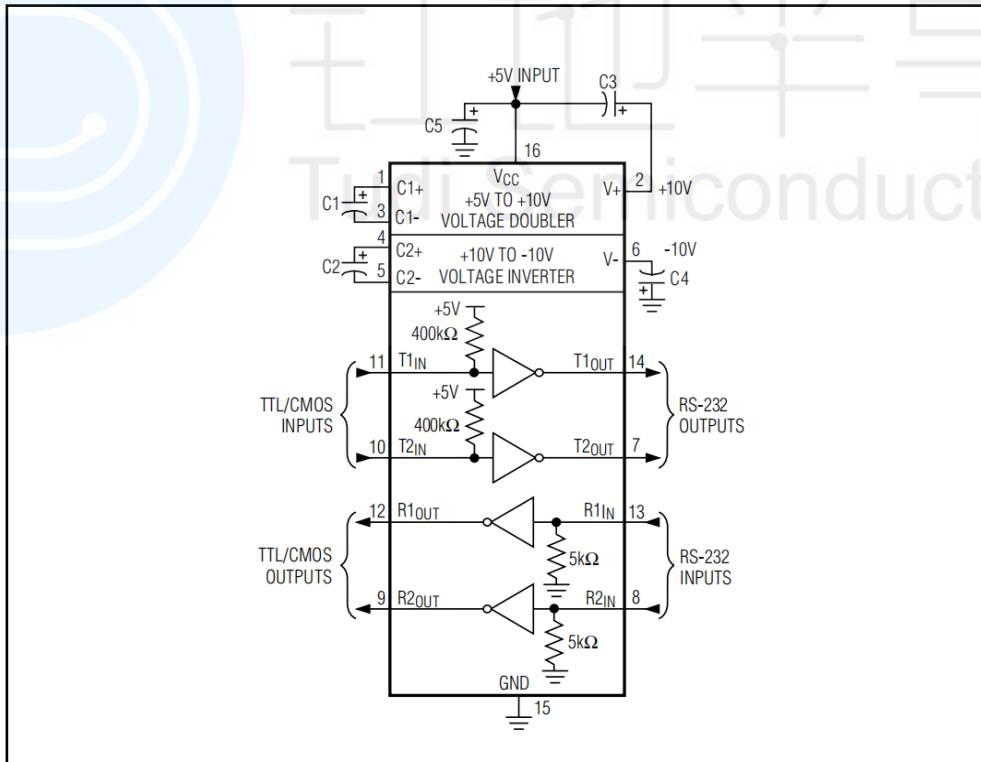
Receiver electrical parameters							
Symbol	Parameter	Test conditions	Rate				Unit
			25°C		-40°C to 85°C		
			min	max	min	max	
Vh	Hysteresis voltage	Vcc=5.0V	0.2	0.9	0.2	1.0	V
Von	On(operation)voltage	Vo 0.1VloL 20 uA		2.4		2.3	
Voff	Off(dropout)voltage	Vo Vcc-01VloH -20 uA	0.8		0.9		
VoL	Output low voltage	loL=3.2 mA Vcc=4.5V	-	0.3		0.4	
VoH	Output high voltage	loH=-1.0 mA Vcc=4.5V	3.6		3.5	-	
RI	Input resistance	Vcc=5.0V	3.0	7.0	3.0	7.0	kOhm
Transmitter electrical parameters							
Symbol	Parameter	Test conditions	Rate				Unit
			25°C		-40°C to 85°C		
			min	max	min	max	
VoL	Output low voltage	Vcc=4.5V VH=2.0V	-	-5.2		-5.0	V
VoH	Output high voltage	Vcc=4.5V VL=0.8V	5.2		5.0	-	
I	Input low current	Vcc=5.5V V = 0V		-1.0		-10.0	uA
IH	Input high current	Vcc=5.5V VH=Vcc		1.0		10.0	
SR	Speed of output frontchange	Vcc=5.0V CL=50 -1000 pF	3.0	30	2.7	27	V/uS
Ro	Output resistance	Vcc=V+=V-=0V Vo=±2V	350	-	300	-	Ohm
Isc	Short circuit outputcurrent	Vcc=5.5V Vo=0V		-5050		-6060	mA kbps
ST	Speed of information transmission	Vcc=4.5V CL=1000 pF	140		150	-	



Dynamic parameters							
Symbol	Parameter	Test conditions	Rate				Unit
			25°C		-40°C to 85°C		
			min	max	min	max	
tPHLR (tPLHR)	Signal propagation delay time	V _{cc} =4.5V CL=150 pF		9.7	-	10	us
tPHLT (tPLHT)	Signal propagation delay time	V _{cc} =4.5V CL=2500 pF		5.0*		6.0*	
Capacitance							
Symbol	Parameter	Test conditions	Rate				Unit
			25°C		-40°C to 85°C		
			min	max	min	max	
CIN	Input capacitance	5.0				9.0	pF
CpD	Dynamic capacitance					90	
Static parameters							
Symbol	Parameter	Test conditions	Rate				Unit
			25°C		-40°C to 85°C		
			min	max	min	max	
I _{cc}	Consumption current static	V _{cc} =5.0V V _o =0V		10.0		14	mA



Truth table			
Inputs	RIn,TIN	H	L
Outputs	RovT,TovT	L	H
H-vol-L	low voltage level;	High level;	
	low voltage level		



Typical Operating Circuit

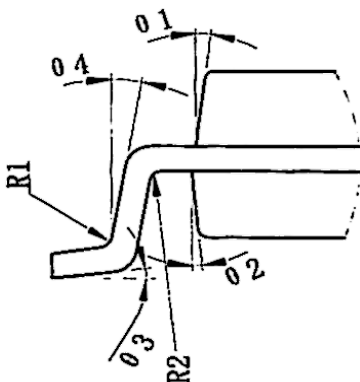
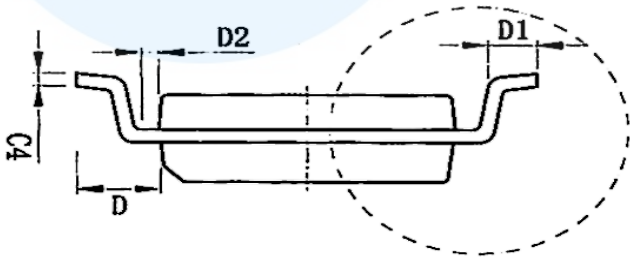
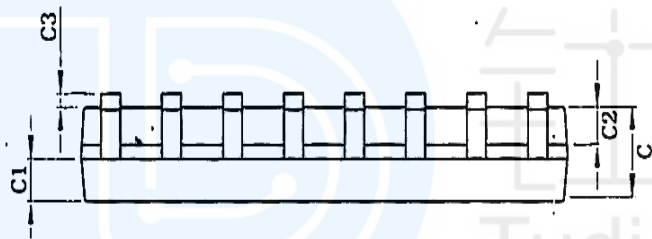
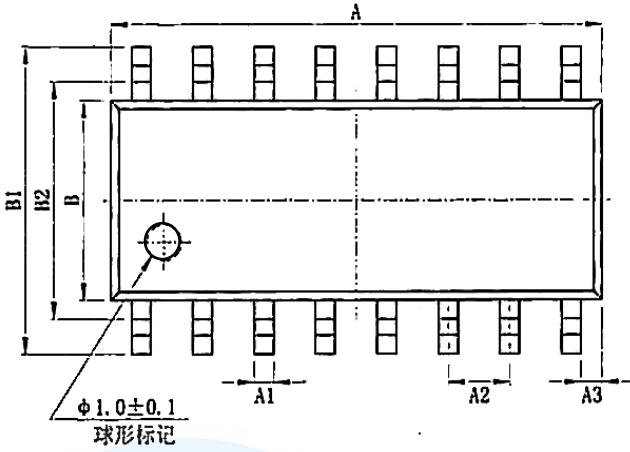


Order information

Order Number	Package	Package Quantity	Marking On The park	Temperature
MAX232ECDR-TUDI	SOP16	Tape,Reel,2500	MAX232EC	0°C to 70°C
MAX232ECDWR-TUDI	SMD16	Tape,Reel,1000	MAX232EC	
MAX232ECPWR-TUDI	TSSOP16	Tape,Reel,2000	MA232EC	
MAX232ECN-TUDI	DIP16	Tube,25,A box of 1000	MAX232ECN	
MAX232EIDR-TUDI	SOP16	Tape,Reel,2500	MAX232EI	- 40°C to 85°C
MAX232EIDWR-TUDI	SMD16	Tape,Reel,1000	MAX232EI	
MAX232EIPWR-TUDI	TSSOP16	Tape,Reel,2000	MB232EI	
MAX232EIN-TUDI	DIP16	Tube,25,A box of 1000	MAX232EIN	



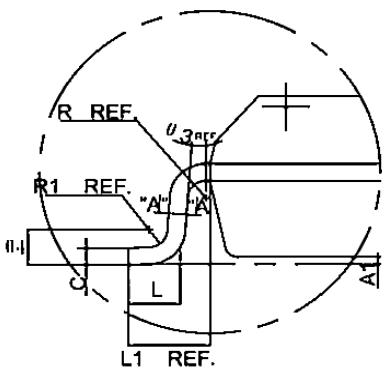
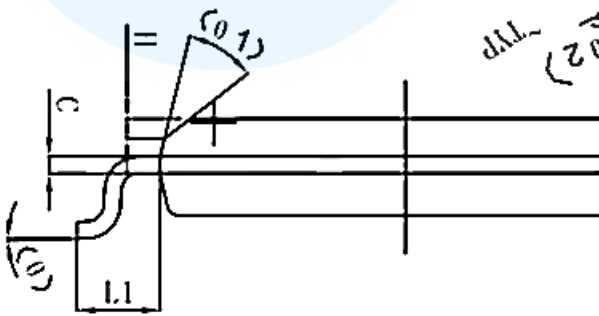
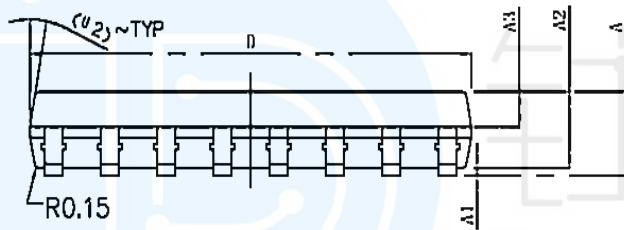
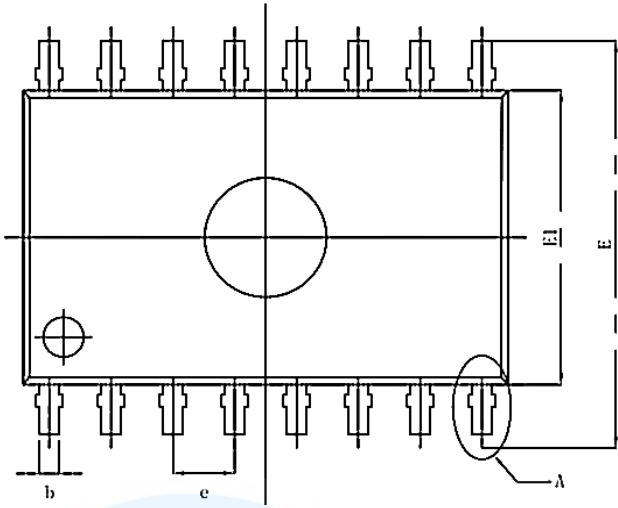
Package SOP16



SIZE	MIN./mm	MAX./mm
SYMBOL		
A	9.80	10.00
A1	0.356	0.456
A2	1.27TYP	
A3	0.302TYP	
B	3.85	3.95
B1	5.84	6.24
B2	5.00 TYP	
C	1.40	1.60
C1	0.61	0.71
C2	0.54	0.64
C3	0.05	0.25
C4	0.203	0.233
D	1.05 TYP	
D1	0.40	0.70
D2	0.15	0.25
R1	0.20TYP	
R2	0.20TYP	
01	8°~12°TYP4	
02	8°~12°TYP4	
03	0°~8°	
04	4°~12°	



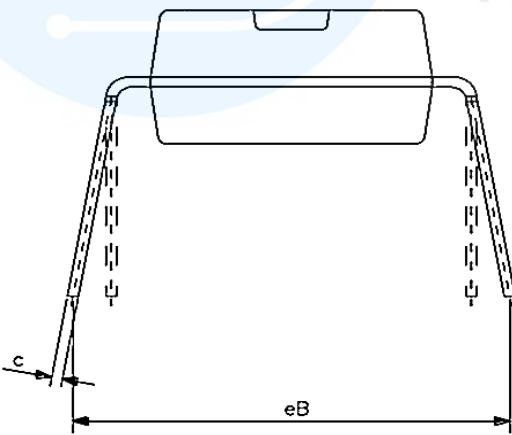
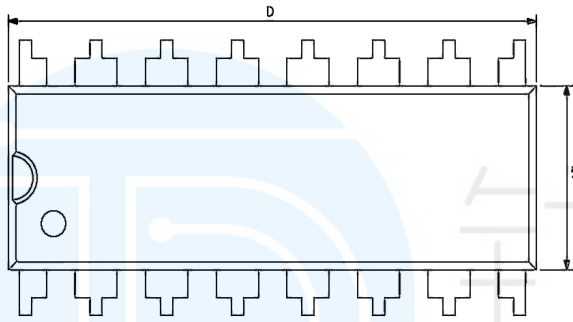
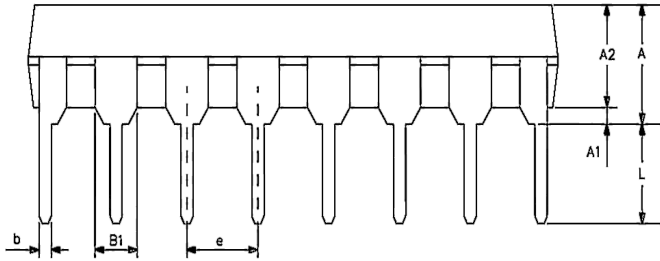
Package SMD16



SIZE SYMBOL	MIN./mm	MAX./mm
A	-	2.65
A1	0.10	0.30
A2	2.25	2.35
A3	0.97	1.07
D	10.10	10.50
E	10.26	10.60
E1	7.30	7.70
e	1.27BSC	
L	0.55	0.85
L1	1.4BSC	
H	0.345	0.365
R	0.20TYP	
R1	0.30TYP	
θ	0°	8°
θ 1	45° TYP	
02	12° TYP	
03	0°	8°
04	0°	10°



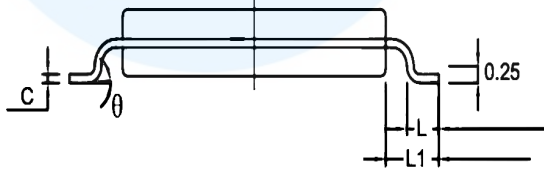
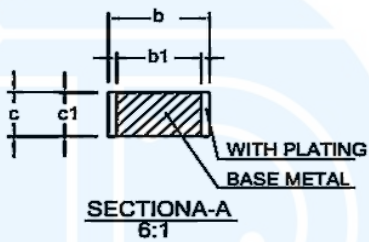
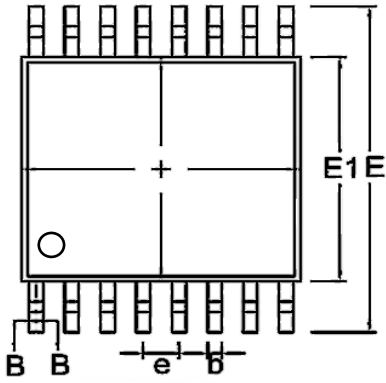
Package DIP16



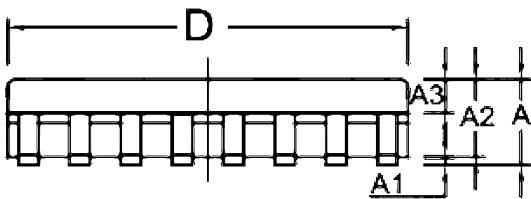
SIZE SYMBOL	MIN./mm	MAX./mm
A2	3.20	3.60
A1	0.51	—
A	3.60	5.33
L	3.00	3.60
b	0.36	0.56
B1	1.52	
D	18.80	19.94
E1	6.20	6.60
e	2.54	
C	0.20	0.36
eB	7.62	9.30
R	0.20TYP	
R1	0.30TYP	
θ	0°	8°
θ_1	45°TYP	
θ_2	12°TYP	
θ_3	0°	8°
θ_4	0°	10°



Package TSSOP16



SIZE SYMBOL	MIN./mm	TYP./mm	MAX./mm
A	--	--	1.20
A1	0.05		0.15
A2	0.90	1.00	1.05
b	0.20	--	0.30
b1	0.19	0.22	0.25
C	0.110	0.127	0.145
cl	0.12	0.13	0.14
D	4.86	4.96	5.06
E	6.20	6.40	6.60
E1	4.30	4.40	4.50
e	0.65BSC		
L	0.45	0.60	0.75
L1	1.00BSC		
	0°	--	8°





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